

# STHVDAC-303

# High voltage BST capacitance controller

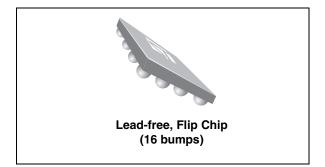
#### Datasheet – production data

## Features

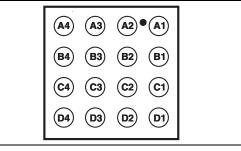
- Dedicated ASIC to control BST tunable capacitances
- Operation compliant with cellular systems requirements
- Integrated boost converter with 3 programmable outputs (from 0 to 30 V)
- Low power consumption
- 3-wire serial interface (30 or 32 bit SPI)
- Available in WLCSP for stand-alone or SiP module integration
- RF tunable passive implementation in mobile phones to optimize the radiated performances

# Application

- Cellular antenna tunable matching network in multi-band GSM/WCDMA mobile phone
- Compatible with open loop antenna tuner applications



#### Figure 1. Pin configuration (bump view)



## Description

The ST BST capacitance controller STHVDAC-303 is a high voltage digital to analog converter (DAC), specifically designed to control and meet the wide tuning bias voltage requirement of the BST tunable capacitances.

It provides 3 independent high voltage outputs, thus having the capability to control 3 different capacitances in parallel. It is fully controlled through a 3-wire serial interface.

BST capacitances are tunable capacitances intended for use in mobile phone application, and dedicated to RF tunable applications. These tunable capacitances are controlled through a bias voltage ranging from 0 to 30 V. The implementation of BST tunable capacitance in mobile phones enables significant improvement in terms of radiated performance, making the performance almost insensitive to the external environment.

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This is information on a product in full production.

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Unit V V kV V °C

# **1** Electrical characteristics

Table I.	Absolute maximum ratings (initially value)	
Symbol	Parameter	Rating
AV <sub>DD</sub>	Analog supply voltage	-0.3 to +5.5
V <sub>dig</sub>	Digital supply voltage	-0.3 to +3.3
V <sub>I/O</sub>	Input voltage logic lines (DATA, CLK, CS)	-0.5 to V <sub>dig</sub> + 0.5
V <sub>ESD (HBM)</sub>	Human body model, JESD22-A114-B, All I/O	2
V <sub>ESD (CDM)</sub>	Charge device model, JESD22-C101-C, All I/O	500
T <sub>stg</sub>	Storage temperature range	-55 to +150
Тj	Maximum junction temperature	150

#### Table 1. Absolute maximum ratings (limiting value)

#### Table 2. Recommended operating conditions

Symbol	Parameter		Unit		
Symbol	i didilicitor	Min.	Тур.	Max.	onit
T <sub>AMB_oP</sub>	Operating ambient temperature	-25	-	+85	°C
AV <sub>DD</sub>	V <sub>DD</sub> Analog supply voltage		-	5	V
V <sub>dig</sub>	Digital supply voltage	1.7	-	3	V
V <sub>IH</sub>	Input voltage logic level HIGH (DATA, CLK, CS)	0.7*V <sub>dig</sub>	-	V <sub>dig</sub> + 0.3	V
V <sub>IL</sub>	Input voltage logic level LOW (DATA, CLK, CS)	-0.3	-	0.35*V <sub>dig</sub>	V



	Conditions: AV <sub>dd</sub> from 2.3 to 5 V, V <sub>dig</sub> from 1.7 to 3 V, T <sub>amb</sub> from -25 °C to +85 °C unless otherwise specified											
Symbol	Parameter	Conditions	Min.	Typ. <sup>(1)</sup>	Max.	Unit						
		Shutdown mode			5	μA						
I <sub>DD</sub>	AV <sub>DD</sub> supply current	Active mode (3 outputs active)		0.67	1	mA						
	V <sub>dig</sub> supply current	Shutdown mode, CS level LOW			10	μA						
l <sub>dig</sub>		Active Mode: (3 outputs active) CS LOW CS HIGH, F <sub>CLK</sub> = 13 MHz CS HIGH, F <sub>CLK</sub> = 26 MHz			0.2 0.6 1	mA						
IIH	Input current logic level HIGH	Any mode, DATA, CLK, CS pins	-2		2	μA						
Ι <sub>ΙL</sub>	Input current logic level LOW	Any mode, DATA, CLK, CS pins	-2		2	μΑ						

#### Table 3. DC characteristics

1. Typical value with typical application condition, V<sub>HV</sub> = 20 V, AV<sub>DD</sub> = 3.3 V, 25 °C, I<sub>load</sub> =  $3*1\mu$ A

#### Table 4. Boost converter characteristics

	Conditions: AV <sub>DD</sub> from 2.3 to 5 V, V <sub>dig</sub> from 1.7 to 3 V, T <sub>amb</sub> from -25 °C to +85 °C unless otherwise specified)											
SymbolParameterConditionsMin.Typ.Max.												
V <sub>hv_low</sub>	Minimum programmable output voltage	Active mode, DAC_boost = 0h		15		V						
V <sub>hv_high</sub>	Maximum programmable output voltage	Active mode, DAC_boost = Fh		30		V						
Resolution	Boost voltage resolution	4 bits DAC		1		V						
Error	DAC boost error	DAC A, DAC B, DAC C and DAC_boost settings according to <i>Table 6</i> .	-6		+6	%V <sub>out</sub>						



Conditio	ns: AV <sub>DD</sub> from 2.3 to 5 V, V	7 <sub>dig</sub> from 1.7 to 3 V, T <sub>amb</sub> from -25 unless otherwise specified)	°C to +8	5 °C, OUT/	A, OUTB,	OUTC,
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
SHUTDOWI	NMODE				Į	
Z <sub>out</sub>	OUTA, OUTB, OUTC output impedance		7			MΩ
ACTIVE MC	DE					
V <sub>OH</sub>	OUTA, OUTB, OUTC maximum output voltage	DAC A = DAC B = DAC C = FFh DAC_boost = Fh, $I_{OH}$ < 10 $\mu$ A	26.5			v
V <sub>OL</sub>	OUTA, OUTB, OUTC minimum output voltage				2	v
R <sub>PD</sub>	OUTA, OUTB, OUTC set in pull down mode	DAC A = DAC B = DAC C = 00h DAC_boost from 0h to Fh			500	Ω
Resolution	Voltage resolution / OUTA, OUTB, OUTC	8 bits DAC, full range 30 V		117.64		mV
V <sub>offset</sub>	Zero scale offset	DAC A, DAC B, DAC C and DAC_boost settings according to <i>Table 6</i> .	-2		+2	LSB
INL	Integral non linearity	Integral non linearity DAC A, DAC B, DAC C and DAC_boost settings according -3 to Table 6.			+3	LSB
DNL	Differential non linearity	DAC A, DAC B, DAC C and DAC_boost settings according to <i>Table 6.</i>	-0.5		+0.5	LSB
∆gain Gain error		DAC A, DAC B, DAC C and DAC_boost settings according to <i>Table 6.</i>	-6		+6	%V <sub>out</sub>
I <sub>sc</sub>	Over current protection	Any DAC output			50	mA

### Table 5. High voltage DAC output characteristics



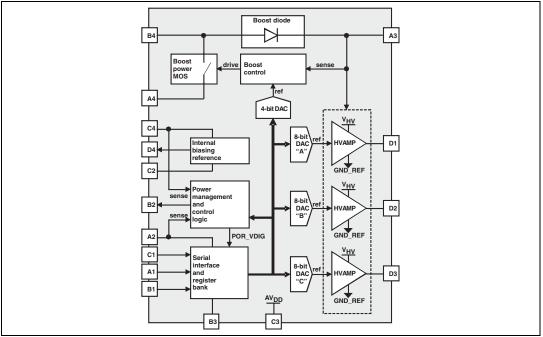
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Conditions: AV <sub>DD</sub> from 2.3 to 5 V, V <sub>dig</sub> from 1.7 to 3 V, T <sub>amb</sub> from -25 °C to +85 °C, OUTA, OUTB, OUTC, unless otherwise specified										
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit				
DAC <sub>MIN</sub>	Minimum DAC setting	DAC_boost from 0H to FH	13h			-				
DAC <sub>MAX</sub>	Maximum DAC setting	DAC_boost = 0h DAC_boost = 1h DAC_boost = 2h DAC_boost = 3h DAC_boost = 4h DAC_boost = 5h DAC_boost = 6h DAC_boost = 7h DAC_boost = 8h DAC_boost = 9h DAC_boost = 9h DAC_boost = Bh DAC_boost = Bh DAC_boost = Ch			5Dh 65h 75h 7Dh 85h 8Dh 95h 9Dh A5h ADh B5h BDh					
VDAC <sub>typ</sub>	Typical DAC output voltage	DAC_boost = Dh DAC_boost = Eh DAC_boost = Fh DAC_boost = 0h, DACx = DAC <sub>MAX</sub> DAC_boost = 1h, DACx = DAC <sub>MAX</sub> DAC_boost = 1h, DACx = DAC <sub>MAX</sub> DAC_boost = 2h, DACx = DAC <sub>MAX</sub> DAC_boost = 3h, DACx = DAC <sub>MAX</sub> DAC_boost = 4h, DACx = DAC <sub>MAX</sub> DAC_boost = 5h, DACx = DAC <sub>MAX</sub> DAC_boost = 6h, DACx = DAC <sub>MAX</sub> DAC_boost = 6h, DACx = DAC <sub>MAX</sub> DAC_boost = 7h, DACx = DAC <sub>MAX</sub> DAC_boost = 8h, DACx = DAC <sub>MAX</sub> DAC_boost = Ah, DACx = DAC <sub>MAX</sub> DAC_boost = Bh, DACx = DAC <sub>MAX</sub> DAC_boost = Ch, DACx = DAC <sub>MAX</sub> DAC_boost = Ch, DACx = DAC <sub>MAX</sub> DAC_boost = Ch, DACx = DAC <sub>MAX</sub>		10.90 11.84 12.77 13.71 14.65 15.59 16.52 17.46 18.40 19.34 20.27 21.21 22.15 23.09 24.02 24.96	C5h CDh D5h	V				

# Table 6. Recommended settings for DAC outputs and DAC\_boost



# 2 Functional block diagram



#### Figure 2. HVDAC functional block diagram

#### Table 7. Signal descriptions

Pin number	Pin number Pin name Des					
A1	DATA	Serial interface / Serial DATA				
A2	V <sub>dig</sub>	Digital supply				
A3	VHV	Boost high voltage output				
A4	GND_BOOST	Ground				
B1	CS	Serial interface / Chip select				
B2	TEST	Test pin / connected to GND in final application				
B3	GND_DIG	Ground				
B4	IND_BOOST	Boost inductance				
C1	CLK	Serial interface / Serial clock				
C2	GND_REF	Analog ground				
C3	AVDD	Analog supply				
C4	AVDD	Analog supply				
D1	OUTA	High voltage output A				
D2	OUTB	High voltage output B				
D3	OUTC	High voltage output C				
D4	R <sub>bias</sub>	Biasing reference resistance				



## 3 Theory of operation

### 3.1 HVDAC output voltages

The HVDAC outputs are directly controlled by programming the 8-bit DAC (DAC A, DAC B and DAC C) through the 3-wire serial interface.

The DAC stages are driven from a reference voltage, generating an analog output voltage driving a high voltage amplifier supplied from the boost converter (see HVDAC block diagram - *Figure 2*).

The HVDAC output voltages are scaled from 0 to 30 V, with 255 steps of 117 mV (30/255 = 0.11764 V). The nominal HVDAC output can be approximated to 117 mV x (DAC value).

For performance optimization, it is also possible to control the boost output voltage (VHV) from 15 V to 30 V, by programming the DAC\_boost value (4 bits / 1 V step).

For proper operation, ST recommends the operation of the HVDAC outputs 2 V below the actual boost output voltage (VHV), to avoid clamping the HVDAC outputs to the boost output voltage.

Recommended settings for DAC A, DAC B and DAC C according to DAC\_boost settings are described in *Table 6.*, considering the overall HVDAC accuracy. These recommended settings are further described on *Figure 5* 

Minimum HVDAC output voltage is also limited to 2 V, meaning minimum DAC command is equal to 19 (or 13h), independent of the DAC\_boost setting.

DAC settings can be programmed outside this recommended operating range, but in this case the HVDAC performance (accuracy and noise) be outside the specified range.

If DAC value is set to 00 h, then the corresponding output is directly connected to GND through a pull-down resistor (500  $\Omega$ ).

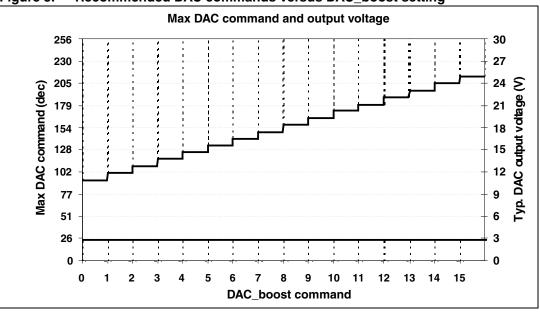


Figure 3. Recommended DAC commands versus DAC\_boost setting

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### 3.2 Operating modes

The following operating modes are accessible through the serial interface:

- Shutdown mode: The HVDAC is switched off, and all the blocks in the control ASIC are switched off. Power consumption is almost zero in this mode, the DAC outputs are in high Z state. The shutdown mode is set by sending a dedicated command through the serial interface.
- Active mode: The HVDAC is switched on and the DAC outputs are fully controlled through the serial interface. The DAC settings can be dynamically modified and the HV outputs will be adjusted according to the specified timing diagrams. Each DAC can be individually controlled and/or switched off according to application requirements. This mode is set and controlled through serial interface commands.

### 3.3 Power-on reset

Power-on reset is implemented on the  $V_{dig}$  supply input, ensuring the HVDAC will be reset to default mode once  $V_{dig}$  supply line rises above a given threshold (typically 1 V). This trigger will force all registers to their default value.

### 3.4 3-wire serial interface

The HVDAC is fully controlled through a 3-wire serial interface (DATA, CS, CLOCK). This interface is further described in the next sections of this document.

### 3.5 Power-up / down sequence

*Table 8* and *Figure 5* describe the HVDAC settling time requirements and recommended timing diagrams.

Switching from shutdown to active mode is triggered by sending a dedicated serial interface command.

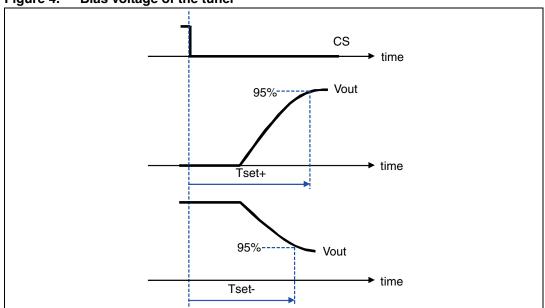
Switching from active to shutdown mode will occur after sending the related command through the 3-wire serial interface.

Active mode can be directly activated from shutdown. In any case the HVDAC will be operational only after  $T_{active}$  (max 300 µs). A settling time ( $T_{set}$ ) is required following each DAC command in active mode. During this settling time the HVDAC output voltages will vary from the initial to the updated DAC command.

## 3.6 Settling time

The ST HVDAC will set the bias voltage of the tuner within 35  $\mu$ s after the chip select is released. The setting time is defined as the time it takes for the output to reach 95% of its final value. A positive setting time (T<sub>set</sub> +) is defined when the output voltage rises and a negative setting time (T<sub>set</sub> -) when it decreases to its final value. See *Figure 4* for details.





#### Figure 4. Bias voltage of the tuner

# 3.7 Power supply sequencing

The ST HVDAC does not require any specific power supply sequencing. It is assumed that the AV<sub>DD</sub> input will be directly supplied from the battery and will then be the first on.

If  $V_{dig}$  supply is pulsed, 5  $\mu s$  are required (max) to settle internal voltages before sending the first command through the 3-wire serial interface.



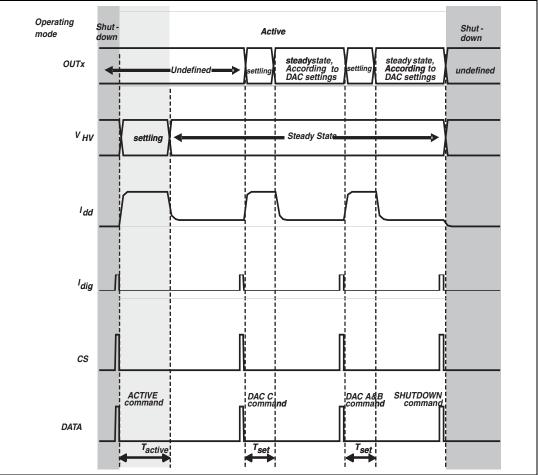
## 3.8 Timing parameters

#### Table 8. Timing parameters

#### Conditions: AV<sub>DD</sub> from 2.3 to 5 V, V<sub>dig</sub> from 1.7 to 3 V, T<sub>amb</sub> from -25 °C to +85 °C, OUTA, OUTB, OUTC, unless otherwise specified

Symbol	nbol Parameter Conditions				
T <sub>active</sub>	Activation time	Internal voltages activation time from shutdown to active mode $C_{hv} = 22 \text{ nF},$ DAC_boost = 07h	300	μs	
T <sub>set+</sub>	Output positive setting time @ 95%	$C_{hv}$ = 22 nF, DAC boost 07h, $V_{out}$ 00h to 88h (worst-case), equivalent load of 15 k $\Omega$ and 1 nF	35	μs	
T <sub>set-</sub>	Output negative setting time @ 95%	$C_{hv}$ = 22 nF, DAC boost 07h, $V_{out}$ 88 h to 13 h, equivalent load of 15 k $\Omega$ and 1 nF	35	μs	

#### Figure 5. Timing diagram example





# 4 Register table

The HVDAC embeds 5 x 16-bit registers. Registers content is described in Table 9.

Registers 1 to 3 are used to control the mode of operations and the HVDAC settings. HVDAC control and settings are thus fully ensured by programming these three registers.

Registers 4 and 5 are reserved for test purpose, and should not be addressed.

Tuble V.	negister table			
Reg #	Name	Purpose	Access type	Size (bits)
1	DAC control DATA register #1	Used to set up OUT C	W	16
2	DAC control DATA register #2	Used to set up OUT A and B	W	16
3	DAC control Mode register	Used to set up the operating modes	W	16
4		Reserved		•
5		Reserved		

Table 9.Register table



# 5 Serial interface specification

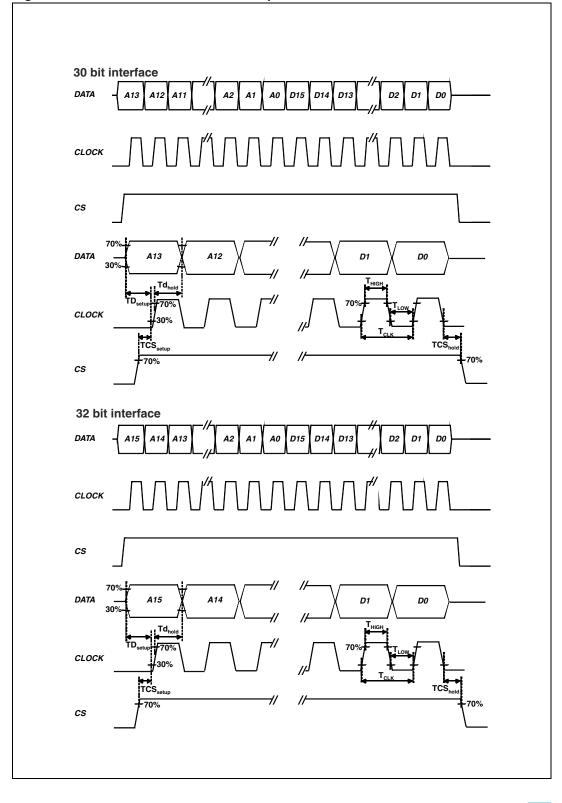
Conditions: AV <sub>DD</sub> from 2.3 to 5 V, V <sub>dig</sub> from 1.7 to 3 V, T <sub>amb</sub> from -25 °C to +85 °C, unless otherwise specified										
Symbol										
F <sub>CLK</sub>	Clock frequency				26	MHz				
Т <sub>СLК</sub>	Clock period		38.4			ns				
T <sub>HIGH</sub>	Clock high time		13			ns				
T <sub>LOW</sub>	Clock low time		13			ns				
N <sub>BIT</sub>	SPI telegram length	STHVDAC-303lx6		30		bits				
N <sub>BIT</sub>	SPI telegram length	STHVDAC-303x6		32		bits				
TCS <sub>setup</sub>	CS setup time	CS setup time 70% of rising edge of CS to 30% of rising edge of 5 first clock cycle		5		ns				
TCS <sub>hold</sub>	CS hold time	30% of falling edge of last CLK cycle to 70% of falling edge of CS	5			ns				
TD <sub>setup</sub>	DATA setup time	Relative to 30% of CLK rising edge	4			ns				
TD <sub>hold</sub>	DATA hold time	Relative to 70% of CLK rising edge	4			ns				
C <sub>CLK</sub>	CLK pin input capacitance	V <sub>OSC</sub> = 30 mV, F = 1 MHz			5	pF				
C <sub>DATA</sub>	DATA pin input capacitance				5	pF				
C <sub>CS</sub>	CS pin input capacitance				5	pF				

#### Table 10. Interface specification



In *Figure 6: 3-wire serial interface description* the data is presented on the falling edge of CLK, and latched on the rising edge of CLK. Command is latched on the falling edge of CS.





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# 6 Serial interface frame structure

A13	A12	A11	A10	<b>A</b> 9	<b>A</b> 8	A7	<b>A</b> 6	A5	<b>A</b> 4	A3	A2	A1	<b>A</b> 0
0	1	0	1	0	0	1	0	0	Х	Х	Х	Х	Х
Fixed		Tuner	Device ID					Re	gister ad	ddress fo	or operat	ion	

#### Table 11. 30-bit frame address decoding

#### Table 12. 32-bit frame address decoding

A15	A14	A13	A12	A11	A10	A9	<b>A</b> 8	A7	<b>A</b> 6	<b>A</b> 5	<b>A</b> 4	A3	A2	A1	<b>A</b> 0
1	1	0	1	0	1	0	0	1	0	0	Х	Х	Х	Х	Х
	Fixed			Tuner			D	evice I	D		Regi	ster ad	dress fo	or oper	ation

#### Table 13. Register decoding

Command	A4	A3	A2	A1	A0	DATA
#1	0	0	0	0	0	<15:8> reserved <7:0> DAC C
#2	0	0	0	0	1	<15:8> DAC B <7:0> DAC A
#3	1	0	0	0	0	Mode selection
#4	1	1	0	0	0	Reserved
#5	1	0	0	1	0	Reserved

#### Table 14. Data decoding for data register [00000]

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	0	0	0	0	0	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0
Reserved DAC C															

#### Table 15. Data decoding for data register [00001]

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0
			DAC	СВ							DA	CA			

#### Table 16. Data decoding for mode selection register [10000]

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	1	[	DAC_BO	DOST		Мс	ode	0	0	DAC A	DAC B	DAC C	0



D11	D10	D9	D8	D7	D6	D3	D2	D1	Co	mments	
	DAC bo	post	I	Мс	ode	DAC A	DAC B	DAC C			
0	0	0	0			х	x	х	VHV = 15V		
0	0	0	1			х	x	х	VHV = 16V		
0	0	1	0			х	x	х	VHV = 17V		
0	0	1	1			х	x	х	VHV = 18V		
0	1	0	0			х	x	х	VHV = 19V		
0	1	0	1			х	x	х	VHV = 20V		
0	1	1	0			х	x	х	VHV = 21V		
0	1	1	1	A ativa		х	x	х	VHV = 22V		
1	0	0	0	<ul> <li>Active mode</li> <li></li> <li></li> </ul>		х	x	х	VHV = 23V		
1	0	0	1			х	x	х	VHV = 24V		
1	0	1	0			х	x	х	VHV = 25V		
1	0	1	1			х	x	х	VHV = 26V		
1	1	0	0			х	x	х	VHV = 27V		
1	1	0	1			х	х	х	VHV = 28V		
1	1	1	0			х	x	х	VHV = 29V		
1	1	1	1			х	х	х	VHV = 30V		
х	х	х	х	0	0	х	x	х	Shutdown mo	ode	
х	х	х	х	0	1	х	х	х	reserved		
х	х	х	х	1	0	х	x	х	Active mode		
х	х	х	х	1	1	х	x	х	reserved		
x	x	x	x	1	0	0	0	0	Active mode / DAC outputs in high Z-state	Any DAC outputs combination possible, as	
x	x	x	x	1	0	1	1	1	Active mode / DAC outputs enabled	described in <i>Table 6.</i>	

Table 17. HV-DAC mode selection - Register [10000]

Table 18.	HVDAC mode selection default settings - Register [10000]

D11	D10	D9	D8	D7	D6	D3	D2	D1
	DAC	boost		Мс	de	DAC A	DAC B	DAC C
0	0 0 0 0		0	0	0	0	0	0

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	J. D	ulu icg		00000]	acraan	. South	igo								
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Reserved										DA	СС			

#### Table 19. Data registers [00000] default settings

### Table 20. Data registers [00001] default settings

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
			DAC	В							DA	CA			



# 7 Application schematic

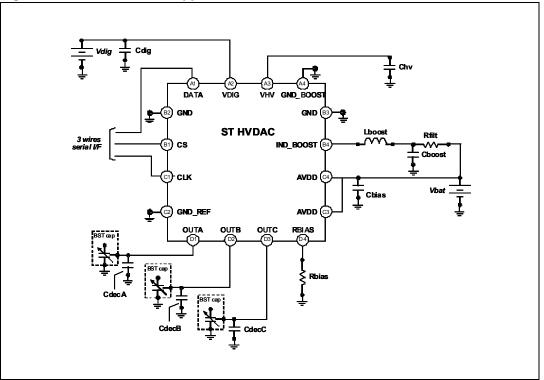
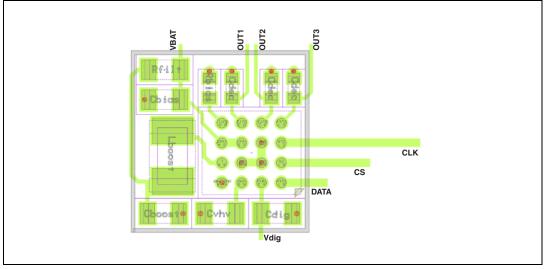


Figure 7. Recommended application schematic







Component	Description	Nominal value	Package (inch)	Package (mm)	Recommended P/N				
C <sub>boost</sub>	Boost supply capacitor	1 µF	0402	1005	Murata: GRM155R60J105KE19D				
1	Boost inductance	15 µH	0603	1608	COILCRAFT: 0603LS-153XGL				
L <sub>boost</sub>	boost inductance	15 μΠ		2014	ABCO: LPS181210T-150M				
R <sub>filt</sub>	Decoupling resistor, 5%	3.3 Ω	0402	1005	Vishay: CRCW04023R30JNED				
C <sub>dig</sub>	Digital supply decoupling	100 nF	0402	1005	Murata: GRM155R71C104KA88D				
C <sub>bias</sub>	Analog supply decoupling	1 µF	0402	1005	Murata: GRM155R60J105KE19D				
R <sub>bias</sub>	Reference bias resistor, 1%	110 kΩ	0201	0603	Multicomp: MCRE000189				
C <sub>hv</sub>	Boost output capacitance, 50 V	22 nF	0402	1005	Murata: GRM155R71H223KA12 Semco: CL21B223KBCNNNC				
C <sub>dec</sub>	Decoupling capacitance, 50 V	100 pF	0201	0603	TDK: C0603COG1H101J				

#### Table 21. Recommended external BOM



# 8 Ordering information schemes

#### Figure 9. Ordering information scheme for 30-bit serial peripheral interface

	STHVDAC	30	3	ļ	- x6
High voltage DAC					
Voltage					
$30 = 30V \max V_{out}$					
Output lines 3 = 3 output lines					
Serial peripheral interface I = 30 bit					
Package					
F6 = Flip Chip, 500 μm pitch C6 = Flip Chip, 500 μm pitch with coating					
00 – The onle, 500 philiphon with coating					

#### Figure 10. Ordering information scheme for 32-bit serial peripheral interface

	STHVDAC	30 	3	-	X
High voltage DAC					
Voltage					
$30 = 30V \max V_{out}$					
Output lines					
3 = 3 output lines					
Package					
F6 = Flip Chip, 500 μm pitch					
C6 = Flip Chip, 500 $\mu$ m pitch with coating					

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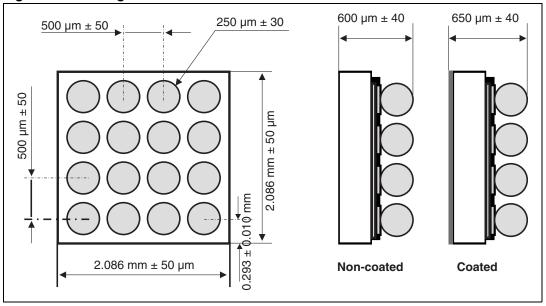


# 9 Package information

- Epoxy meets UL94, V0
- Lead-free package

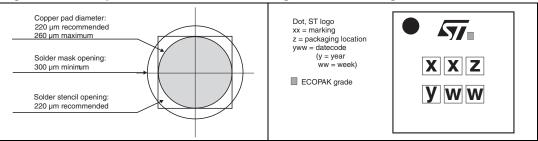
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK<sup>®</sup> is an ST trademark.

Figure 11. Package dimensions



#### Figure 12. Footprint

#### Figure 13. Marking





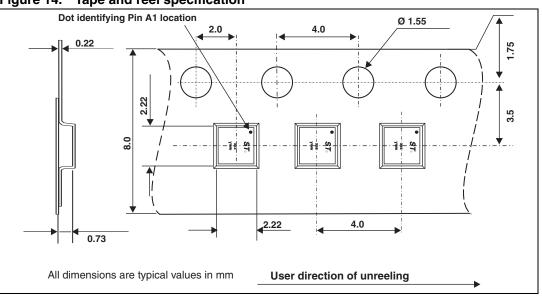


Figure 14. Tape and reel specification

# 10 Ordering information

#### Table 22.Ordering information

Order code	SPI	Marking	Package	Weight	Base qty	Delivery mode	
STHVDAC-303IF6	30 bits	PC	Flip Chip	5 mg			
STHVDAC-303IC6	30 bits	PE	Coated Flip Chip	5.3 mg	5000	Tape and reel	
STHVDAC-303F6	32 bits	PA	Flip Chip	5 mg	5000	Tape and Teel	
STHVDAC-303C6	32 bits	PD	Coated Flip Chip	5.3 mg			

Note:

More information is available in the STMicroelectronics Application note: AN1235: "Flip Chip: Package description and recommendations for use"



# 11 Revision history

#### Table 23. Document revision history

Date	Revision	Changes
14-Mar-2011	1	Initial release.
04-Apr-2012	2	Corrected typographical error in Application.
05-Nov-2012	3	Updated document status.



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